

SuperMOS – DFN1006-3L -20V BV_{DSS} 580mΩ R_{DS(ON)} I_D P-channel MOSFET

1. Description

The ES3139KE is P-Channel enhancement MOS Field Effect Transistor. Uses advanced trench technology and design to provide excellent R_{DS(ON)} with low gate charge. Device is suitable for use in DC-DC conversion, power switch and charging circuit. Standard Product ES3139KE is Pb-free.

2. Features

- -20V, R_{DS(ON)}=580mΩ(Typ), V_{GS}=-4.5V
R_{DS(ON)}=855mΩ(Typ), V_{GS}=-2.5V
R_{DS(ON)}=1350mΩ(Typ), V_{GS}=-1.8V
- Use trench MOSFET technology
- High density cell design for low R_{DS(on)}
- Material: Halogen free
- Reliable and rugged
- Avalanche Rated
- Low leakage current

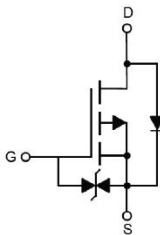
3. Applications

- PWM applications
- Load switch
- Power management in portable/desktop PCs
- DC/DC conversion

4. Ordering Information

Part Number	Package	Marking	Material	Packing	Quantity per reel	Flammability Rating	Reel Size
ES3139KE	DFN1006-3L	39KE	Halogen free	Tape & Reel	10K PCS	UL 94V-0	7 inches

5. Pin Configuration and Functions

Pin	Function	Outline	Circuit Diagram
1	Gate		
2	Source		
3	Drain		

6. Specification

Absolute Maximum Rating & Thermal Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		BV_{DSS}	-20	V
Gate-Source Voltage		V_{GS}	±12	V
Continuous Drain Current	$T_A=25^{\circ}\text{C}$	I_D	-0.65	A
	$T_A=70^{\circ}\text{C}$		-0.52	
Maximum Power Dissipation		P_D	0.9	W
Pulsed Drain Current		I_{DM}	-2.0	A
Operating Junction Temperature		T_J	150	°C
Lead Temperature		T_L	260	°C
Storage Temperature Range		T_{stg}	-55 to 150	°C

Thermal resistance ratings

Single Operation					
Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient Thermal Resistance	$t \leq 10\text{s}$	$R_{\theta JA}$		138	°C/W

ES3139KE

Rev-1.3

Electrical Characteristics

At TA = 25°C unless otherwise specified

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =-250uA	-20			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V, V _{GS} =0V			-1	uA
Gate-to-source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±10V			±10	uA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} =V _{DS} , I _D =-250uA	-0.35	-0.62	-1.2	V
Drain-to-source On-resistance	R _{DS(on)}	V _{GS} =-4.5V, I _D =-0.5A		580	850	mΩ
		V _{GS} =-2.5V, I _D =-0.3A		855	1200	
		V _{GS} =-1.8V, I _D =-0.2A		1350	2000	
CHARGES, CAPACITANCES AND GATE RESISTANCE						
Input Capacitance	C _{ISS}	V _{GS} =0V, f=1MHz, V _{DS} =-10V		71		pF
Output Capacitance	C _{OSS}			20		
Reverse Transfer Capacitance	C _{RSS}			15		
Total Gate Charge	Q _{G(TOT)}	V _{GS} =-4.5V, V _{DS} =-10V, I _D =-0.5A		1.25		nC
Gate-to-Source Charge	Q _{GS}			0.38		
Gate-to-Drain Charge	Q _{GD}			0.28		
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(ON)}	V _{GS} =-4.5V, V _{DS} =-10V, R _L =2.5Ω, R _G =-3Ω		4		ns
Rise Time	t _r			19		
Turn-Off Delay Time	t _{d(OFF)}			16		
Fall Time	t _f			25		
BODY DIODE CHARACTERISTICS						
Forward Voltage	V _{SD}	V _{GS} =0V, I _S =-0.5A			-1.5	V

7. Typical Characteristic

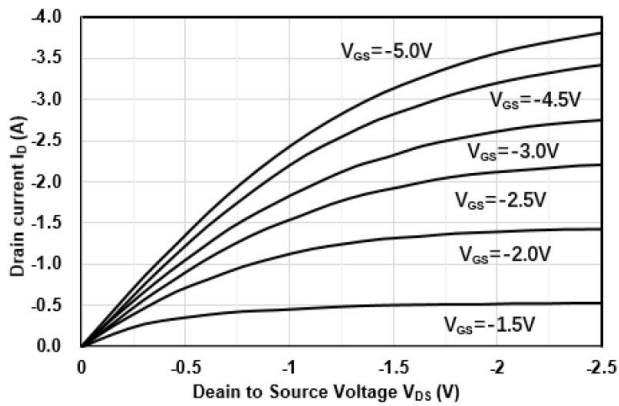


Figure1. Output Characteristics

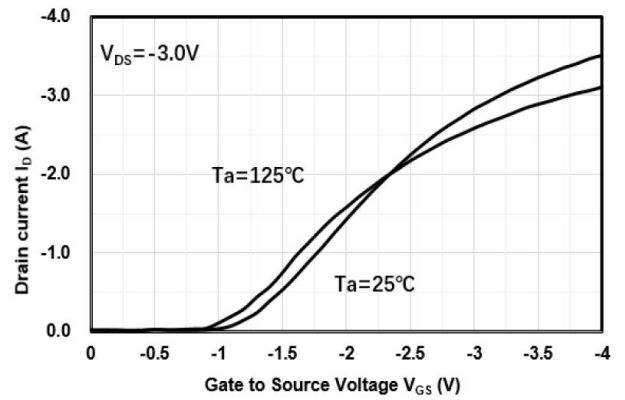


Figure2. Transfer Characteristics

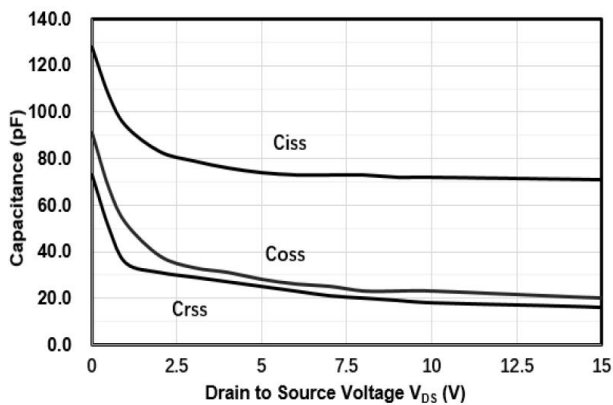


Figure3. Capacitance Characteristics

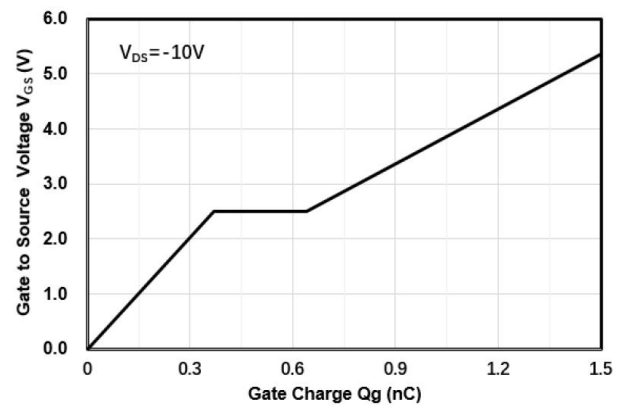


Figure4. Gate Charge

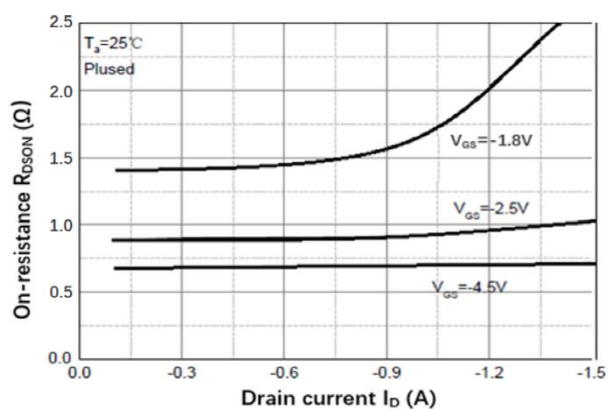


Figure5. Drain-Source on Resistance

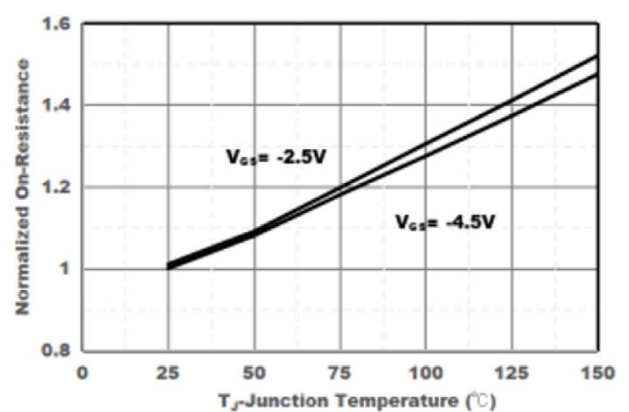


Figure6. Drain-Source on Resistance

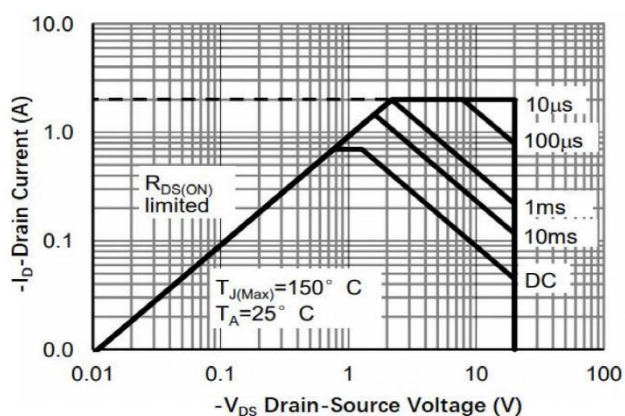


Figure7. Safe Operation Area

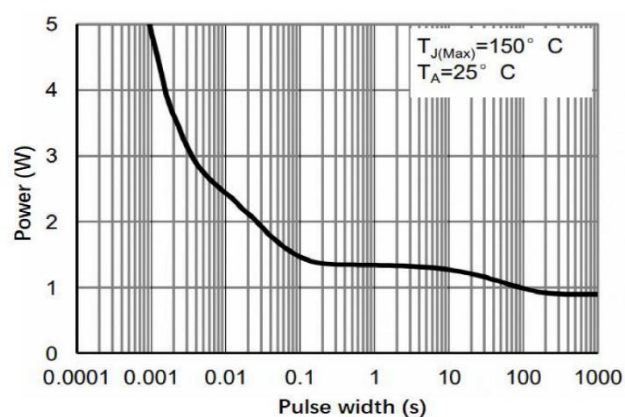


Figure8. Pulse Power Rating Junction-to Ambient

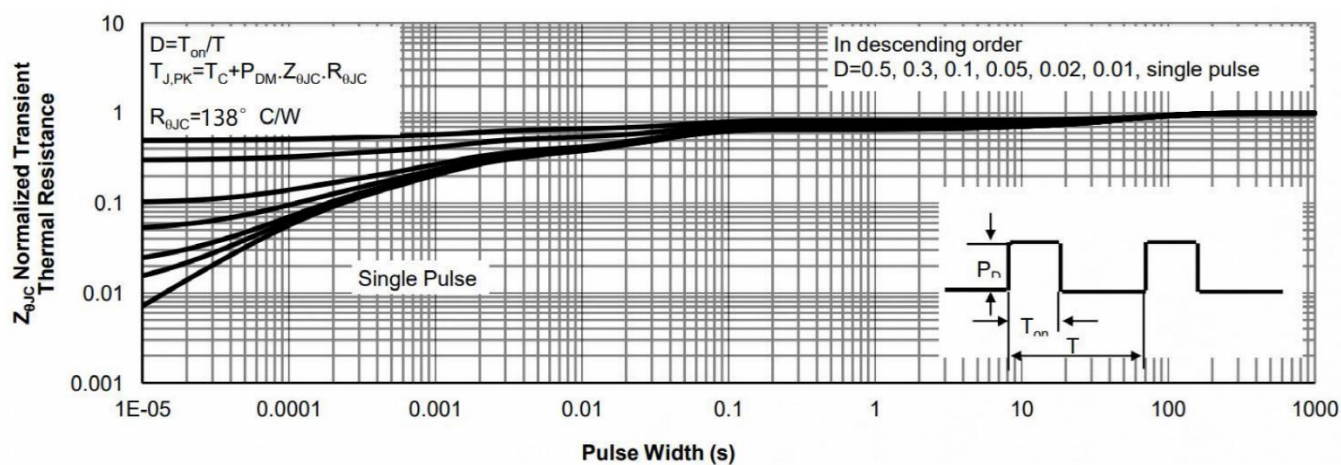
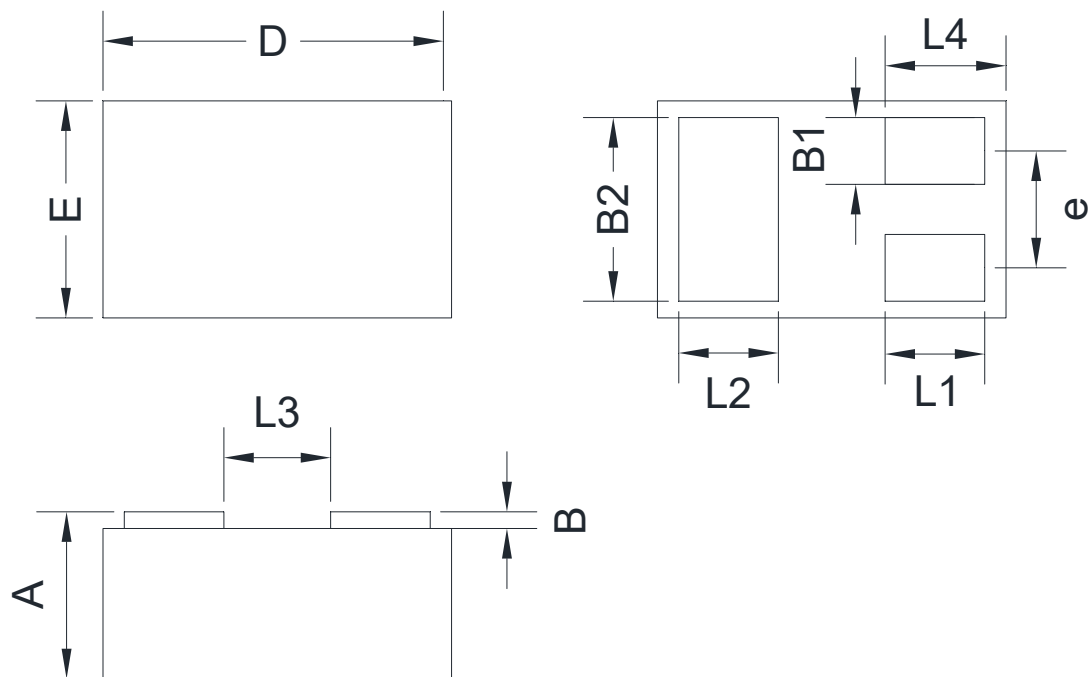


Figure9. Normalized Maximum Transient Thermal Impedance

8. Dimension (DFN1006-3L)



Symbol	Millimeters		Symbol	Millimeters	
	Min	Max		Min	Max
A	0.40	0.50	e	0.35	
B	0.00	0.05	L1	0.20	0.30
B1	0.10	0.20	L2	0.20	0.30
B2	0.45	0.55	L3	0.39	
D	0.90	1.05	L4	0.25	0.35
E	0.50	0.65			

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